

# CHENZHUO LI

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## EDUCATION

### Beihang University

Ph.D. candidate in Solid Mechanics. GPA: 3.8/4.0

Beijing, China

Expected Jun 2023

### Beihang University

B.S. in Flying Vehicle Propulsion Engineering. GPA: 3.7/4.0

Beijing, China

Jun 2018

### Polytechnic University of Milan

Undergraduate International Exchange Program

Milan, Italy

Sep 2017 – Feb 2018

## AWARDS AND HONORS

- First-Class Academic Scholarship 2020
- Freshman Merit Scholarship 2019
- First-Class Academic Scholarship 2019
- First-Class Academic Scholarship 2018
- Full Scholarship for Undergraduate Exchange Program (China Scholarship Council) 2018
- Third Prize for the 26<sup>th</sup> “Feng Ru Cup” Competition 2016
- Student Research Training Grant (RMB3500) 2015-2016

## PUBLICATIONS

(# *donates equal contribution*)

- **C Li** and B Pan (in preparation). “Rapid and repeatable fluorescent speckle pattern fabrication using a handheld inkjet printer.”
- **C Li** and B Pan (to be submitted). “A correction method for heatwave distortions based on fluorescent color digital image correlation.”
- B Fu<sup>#</sup>, **C Li**<sup>#</sup>, P Ou, and B Dong (under revision). “Enhanced digital gradient sensing using backlight digital speckle target.”
- B Dong, **C Li**, and B Pan (under revision). “Fluorescent 2D digital image correlation with built-in coaxial illumination for deformation measurement in space-constrained scenarios.”
- **C Li**, H Luo, and B Pan (2020). “High-throughput measurement of coefficient of thermal expansion using a high-resolution DSLR camera and digital image correlation.” *Rev Sci Instrum* 91(10): 105106
- B Dong<sup>#</sup>, **C Li**<sup>#</sup>, and B Pan (2020). “Fluorescent digital image correlation applied for macroscale deformation measurement.” *Appl Phys Lett* 117(4): 044101
- B Dong<sup>#</sup>, **C Li**<sup>#</sup>, and B Pan (2019). “Ultrasensitive video extensometer using single-camera dual field-of-view telecentric imaging system.” *Opt Lett* 44(18): 4499-4502
- **C Li**<sup>#</sup>, B Dong<sup>#</sup>, and B Pan (2019). “A flexible and easy-to-implement single-camera microscopic 3D digital image correlation technique.” *Meas Sci Technol* 30(8): 085002

## PRESENTATIONS

- “New exploration and application of fluorescent digital image correlation.” *International Digital Image Correlation Society Conference*, Virtual, Oct 2020
- “New exploration and application of fluorescent digital image correlation.” *The 1<sup>st</sup> International Forum on 3D Optical Sensing and Application*, Virtual, Oct 2020 (**Invited**)
- “High-throughput CTE determination of bulk materials based on DSLR and DIC.” (in Chinese) *The 26<sup>th</sup> Annual Conference of Beijing Society of Theoretical and Applied Mechanics*, Beijing, Jan 2020

## **RESEARCH EXPERIENCE**

### **Institute of Solid Mechanics, Beihang University**

Beijing, China

*Graduate Researcher*

Oct 2018 – Present

- Discovered the advantages of fluorescent speckle in macroscale digital image correlation, explored its repeatable fabrication, and applications in coaxial illumination, heatwave distortion correction, etc.
- Simplified the speckle target in the digital gradient sensing using backlight technique and improved the measurement accuracy
- Designed and executed high-throughput measurement of coefficients of thermal expansion of bulk materials using a digital single lens reflex and digital image correlation
- Developed an ultrasensitive video extensometer based on the idea of field-of-view separation and telecentric imaging
- Developed a single-camera three-dimensional microscopic digital image correlation technique
- Assessed the drift error and distortion between slices obtained by laser scanning confocal microscope (LSCM) using microscale digital image correlation
- Performed digital image correlation on scanning electron microscope images and analyzed the factors affecting the quality of the microscale speckle pattern

### **Center of Space Exploration (Chongqing University), Ministry of Education**

Beijing, China

*Experiment Assistant*

Jun – Sep 2018

- Assisted in the experiment preparation of the Chang'e-4 Lunar Biosphere Mini-Ecosystem
- Operated the equipment, collected experimental data and monitored the health of the mini-ecosystem
- Performed analysis on the acquired data, deduced the internal status of the mini-ecosystem and conducted troubleshooting when necessary

### **Institute of Solid Mechanics, Beihang University**

Beijing, China

*Undergraduate Researcher*

Sep 2017 – Jun 2018

- Generated finite element model of 3D closed-cell porous materials with spherical/polyhedral pores using MATLAB, AutoCAD, Rhinoceros and Hypermesh
- Performed finite element analysis using ABAQUS and investigated the effective bulk modulus of porous materials with porosity from 0 to 99%

### **Student Research Training Program, Beihang University**

Beijing, China

*Team Leader and APP developer*

May 2015 – Oct 2016

- Planned the project schedule and managed the research grant
- Developed a remote-control toy car based on Raspberry Pi and a home-made IOS app, realizing motion control and real-time video streaming

## **ADDITIONAL EXPERIENCE**

### **Wroclaw University of Science and Technology**

Wrocław, Poland

*Summer School in MEMS and Microsystems*

Jul 2019

### **University of Cambridge**

Cambridge, UK

*Summer School in Nanotechnology and Quantum Technologies*

Jul 2017

### **Peter the Great St. Petersburg Polytechnic University**

St. Petersburg, Russia

*Summer School in Turbomachinery*

Aug 2016

### **AIIESEC International Inc.**

Hyderabad, India

*International Volunteer in Women Empowerment*

Jul – Aug 2015

## **SKILLS**

**Computer:** MATLAB, Python, 2D/3D Modelling, Finite Element Analysis

**Laboratory:** Scanning Electron Microscope, Raspberry Pi, Arduino

**Languages:** Chinese(native), English(proficient), Italian(beginner)

## **REFERENCES**

Duoqi Shi, Ph.D.

Full Professor

School of Energy and Power Engineering

Beihang University

Beijing, China

[shdq@buaa.edu.cn](mailto:shdq@buaa.edu.cn)

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